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TC 1700

Our Case No. 10541/279  
Visteon Case No. V200-0303

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Application of:

Peter J. Sinkunas, et al.

Serial No. 09/820,092

Filing Date: March 28, 2001

For: FLEX TO FLEX SOLDERING BY  
DIODE LASER

Examiner: Colleen P. Cooke

Group Art Unit No. 1725

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**AMENDMENT**

Dear Sir:

In response to the outstanding Office Action mailed October 2, 2003,  
Applicants submit the following.

**Amendments to the Claims** are reflected in the listing of claims which begins on  
page 2 of this paper.

**Remarks/Arguments** begin on page 10 of this paper.

12/08/2003 EFLORES 00000057 061500 09820092

01 FC:1201 172.00 DA

02 FC:1202 288.00 DA